



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

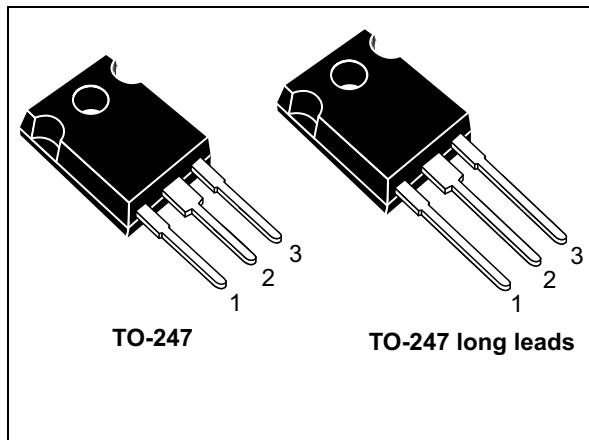
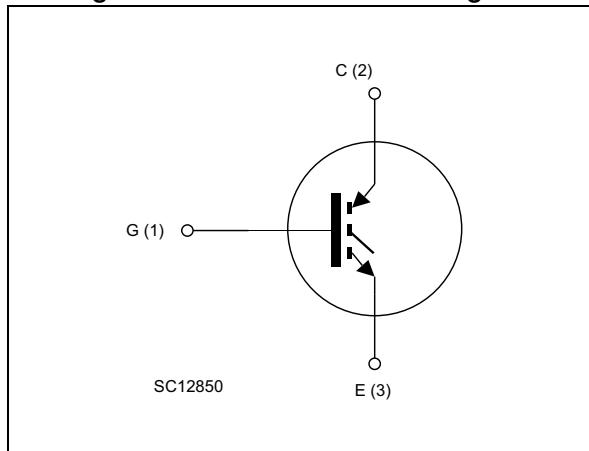


Figure 1. Internal schematic diagram



Features

- Maximum junction temperature: $T_J = 175 \text{ }^\circ\text{C}$
- High speed switching series
- Minimized tail current
- $V_{CE(\text{sat})} = 2.1 \text{ V (typ.)} @ I_C = 15 \text{ A}$
- 5 μs minimum short-circuit withstand time at $T_J=150 \text{ }^\circ\text{C}$
- Safe paralleling
- Low thermal resistance

Applications

- Uninterruptible power supply
- Welding machines
- Photovoltaic inverters
- Power factor correction
- High frequency converters

Description

These devices are IGBTs developed using an advanced proprietary trench gate field-stop structure. These devices are part of the improved H series of IGBTs, which represent an optimum compromise between conduction and switching loss to maximize the efficiency of high frequency converters. Furthermore, a slightly positive $V_{CE(\text{sat})}$ temperature coefficient and very tight parameter distribution result in safer paralleling operation.

Table 1. Device summary

Order code	Marking	Package	Packing
STGW15H120F2	G15H120F2	TO-247	Tube
STGWA15H120F2	G15H120F2	TO-247 long leads	Tube

Contents

1	Electrical ratings	3
2	Electrical characteristics	4
2.1	Electrical characteristics (curves)	6
3	Test circuits	11
4	Package information	12
4.1	TO-247 package information	12
4.2	TO-247 long leads, package information	14
5	Revision history	16

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{CES}	Collector-emitter voltage ($V_{GE} = 0$)	1200	V
I_C	Continuous collector current at $T_C = 25^\circ\text{C}$	30	A
I_C	Continuous collector current at $T_C = 100^\circ\text{C}$	15	A
$I_{CP}^{(1)}$	Pulsed collector current	60	A
V_{GE}	Gate-emitter voltage	± 20	V
P_{TOT}	Total dissipation at $T_C = 25^\circ\text{C}$	259	W
T_{STG}	Storage temperature range	-55 to 150	$^\circ\text{C}$
T_J	Operating junction temperature	-55 to 175	$^\circ\text{C}$

1. Pulse width limited by maximum junction temperature.

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R_{thJC}	Thermal resistance junction-case	0.58	$^\circ\text{C}/\text{W}$
R_{thJA}	Thermal resistance junction-ambient	50	$^\circ\text{C}/\text{W}$

2 Electrical characteristics

$T_J = 25^\circ\text{C}$ unless otherwise specified.

Table 4. Static characteristics

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(\text{BR})\text{CES}}$	Collector-emitter breakdown voltage ($V_{GE} = 0$)	$I_C = 2 \text{ mA}$	1200			V
$V_{CE(\text{sat})}$	Collector-emitter saturation voltage	$V_{GE} = 15 \text{ V}, I_C = 15 \text{ A}$		2.1	2.6	V
		$V_{GE} = 15 \text{ V}, I_C = 15 \text{ A}$ $T_J = 125^\circ\text{C}$		2.4		
		$V_{GE} = 15 \text{ V}, I_C = 15 \text{ A}$ $T_J = 175^\circ\text{C}$		2.5		
$V_{GE(\text{th})}$	Gate threshold voltage	$V_{CE} = V_{GE}, I_C = 500 \mu\text{A}$	5	6	7	V
I_{CES}	Collector cut-off current ($V_{GE} = 0$)	$V_{CE} = 1200 \text{ V}$			25	μA
I_{GES}	Gate-emitter leakage current ($V_{CE} = 0$)	$V_{GE} = \pm 20 \text{ V}$			± 250	nA

Table 5. Dynamic characteristics

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
C_{ies}	Input capacitance	$V_{CE} = 25 \text{ V}, f = 1 \text{ MHz},$ $V_{GE} = 0$	-	1300	-	pF
C_{oes}	Output capacitance		-	105	-	pF
C_{res}	Reverse transfer capacitance		-	32	-	pF
Q_g	Total gate charge	$V_{CC} = 960 \text{ V}, I_C = 15 \text{ A},$ $V_{GE} = 15 \text{ V}$, see Figure 23	-	67	-	nC
Q_{ge}	Gate-emitter charge		-	8	-	nC
Q_{gc}	Gate-collector charge		-	38	-	nC

Table 6. Switching characteristics (inductive load)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$	Turn-on delay time	$V_{CE} = 600 \text{ V}, I_C = 15 \text{ A}, R_G = 10 \Omega, V_{GE} = 15 \text{ V}$, see Figure 22	-	23	-	ns
t_r	Current rise time		-	7.4	-	ns
$(di/dt)_{on}$	Turn-on current slope		-	1621	-	A/ μs
$t_{d(off)}$	Turn-off delay time		-	111	-	ns
t_f	Current fall time		-	111	-	ns
$E_{on}^{(1)}$	Turn-on switching loss		-	0.38	-	mJ
$E_{off}^{(2)}$	Turn-off switching loss		-	0.37	-	mJ
E_{ts}	Total switching loss		-	0.75	-	mJ
$t_{d(on)}$	Turn-on delay time	$V_{CE} = 600 \text{ V}, I_C = 15 \text{ A}, R_G = 10 \Omega, V_{GE} = 15 \text{ V}, T_J = 175 \text{ }^\circ\text{C}$, see Figure 22	-	23.5	-	ns
t_r	Current rise time		-	8	-	ns
$(di/dt)_{on}$	Turn-on current slope		-	1525	-	A/ μs
$t_{d(off)}$	Turn-off delay time		-	118	-	ns
t_f	Current fall time		-	253	-	ns
$E_{on}^{(1)}$	Turn-on switching loss		-	0.65	-	mJ
$E_{off}^{(2)}$	Turn-off switching loss		-	0.93	-	mJ
E_{ts}	Total switching loss		-	1.58	-	mJ
t_{sc}	Short-circuit withstand time	$V_{CE} = 600 \text{ V}, V_{GE} = 15 \text{ V}, T_J = 150 \text{ }^\circ\text{C}$,	5		-	μs

1. Energy loss include reverse recovery of the external diode. The diode is the same of the co-packed STGW15H120DF2

2. Turn-off loss include also the tail of the collector current.

2.1 Electrical characteristics (curves)

Figure 2. Power dissipation vs. case temperature

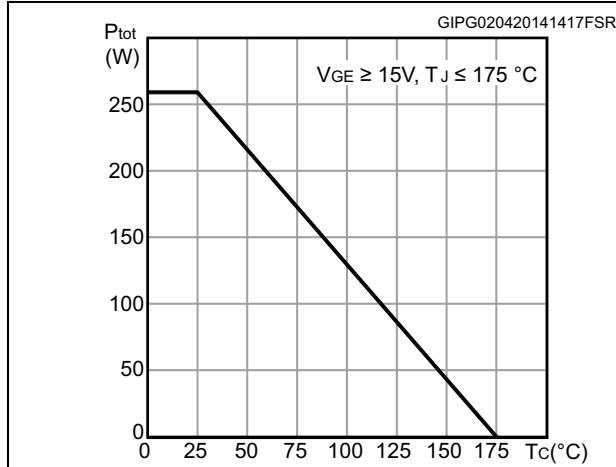


Figure 3. Collector current vs. case temperature

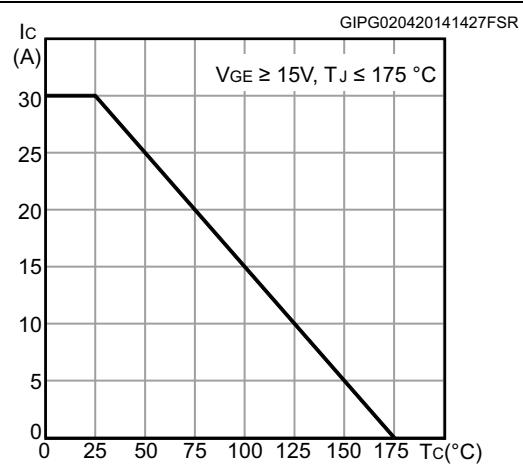


Figure 4. Output characteristics ($T_J = 25^\circ\text{C}$)

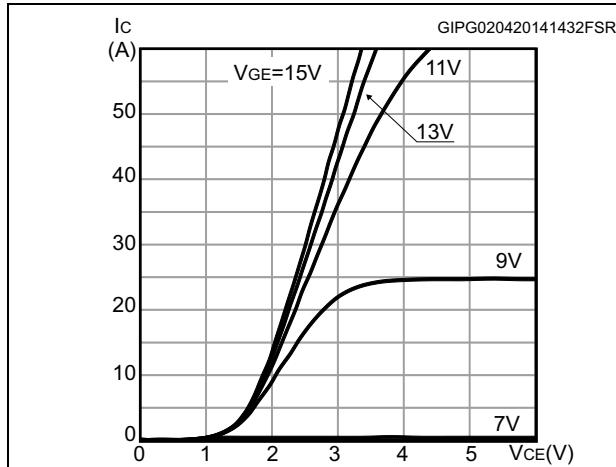


Figure 5. Output characteristics ($T_J = 175^\circ\text{C}$)

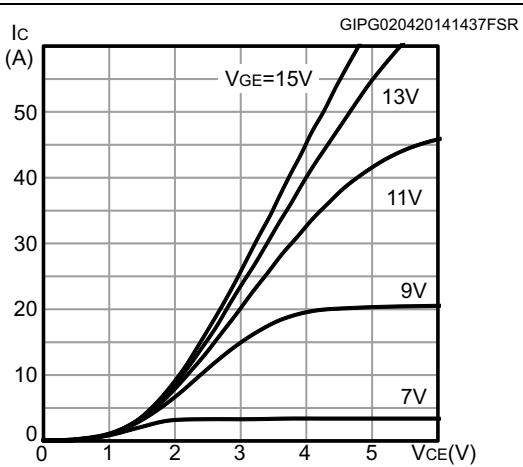


Figure 6. $V_{CE(\text{sat})}$ vs. junction temperature

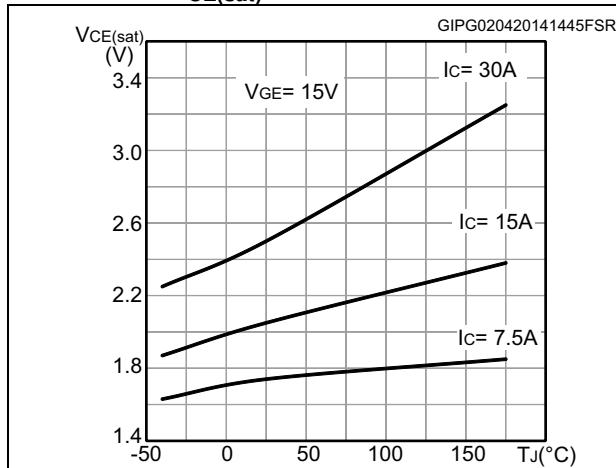


Figure 7. $V_{CE(\text{sat})}$ vs. collector current

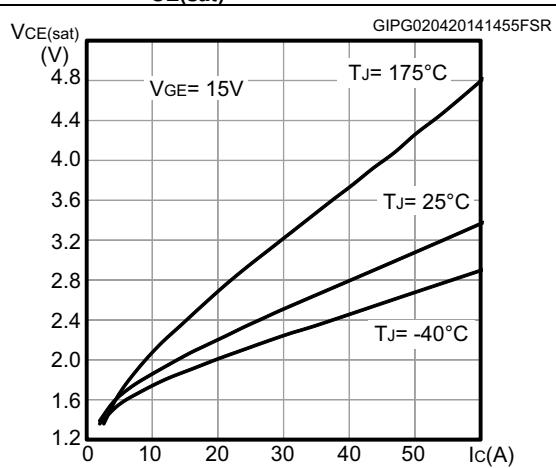


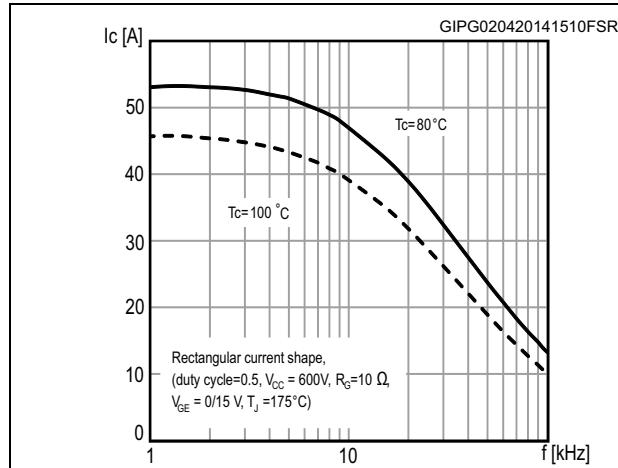
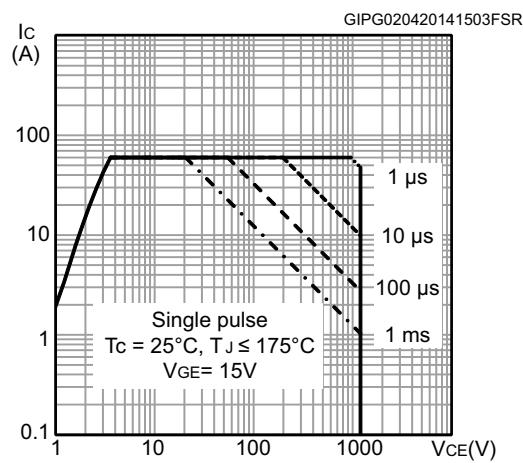
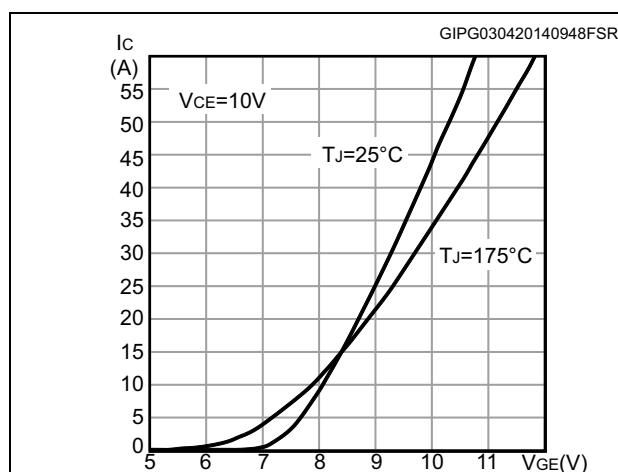
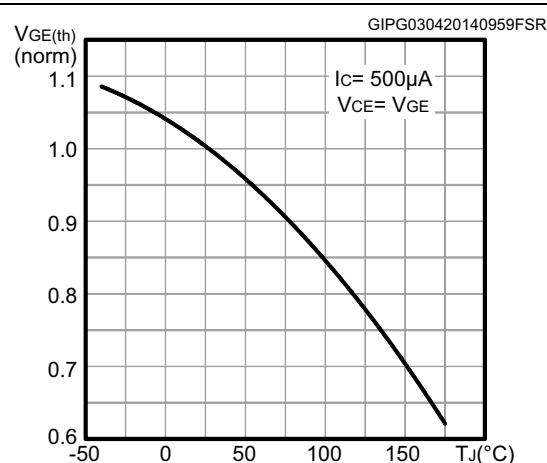
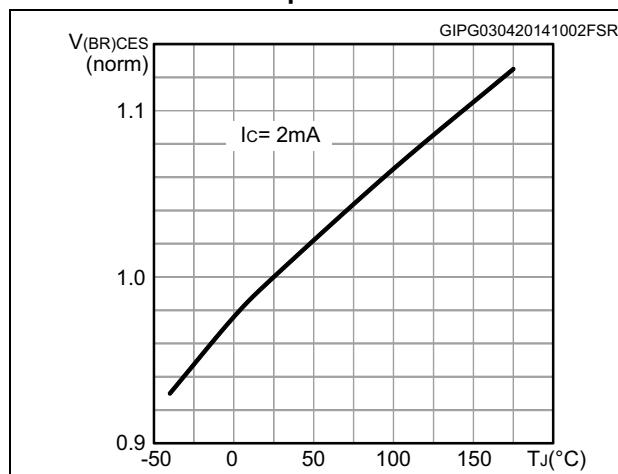
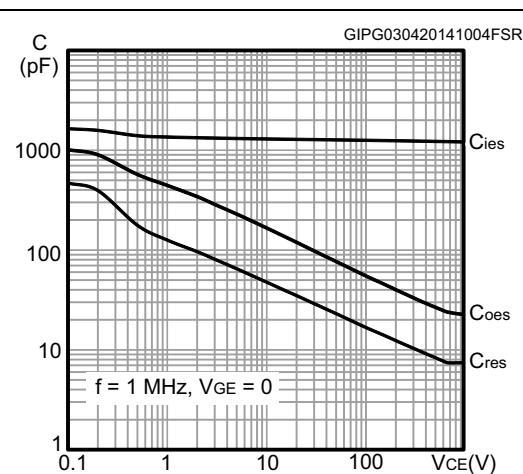
Figure 8. Collector current vs. switching frequency**Figure 9. Forward bias safe operating area****Figure 10. Transfer characteristics****Figure 11. Normalized $V_{GE(\text{th})}$ vs junction temperature****Figure 12. Normalized $V_{(BR)CES}$ vs. junction temperature****Figure 13. Capacitance variation**

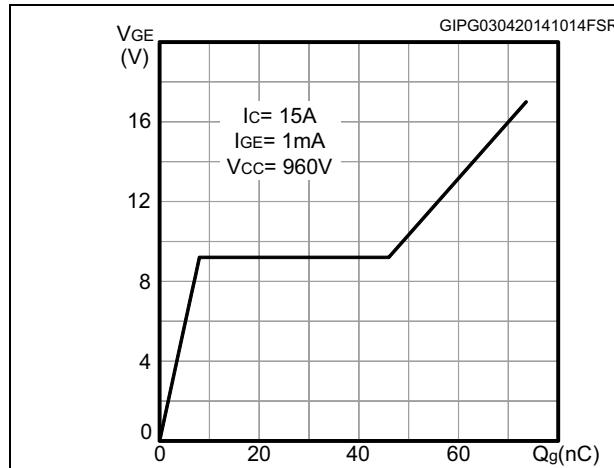
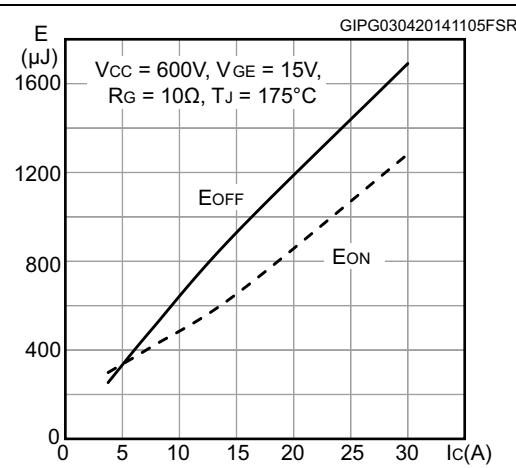
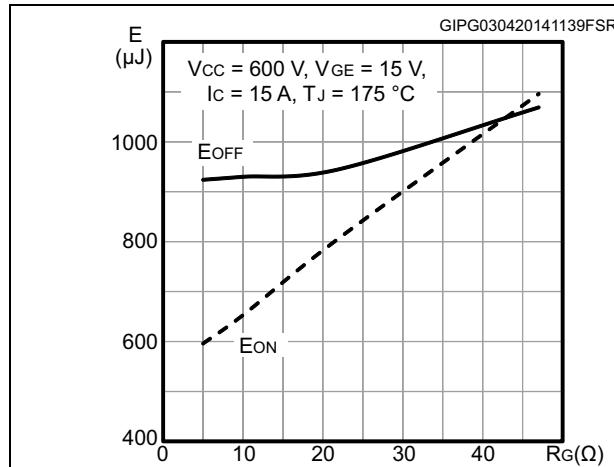
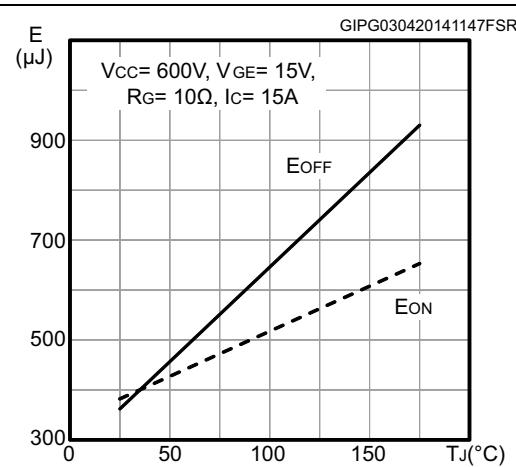
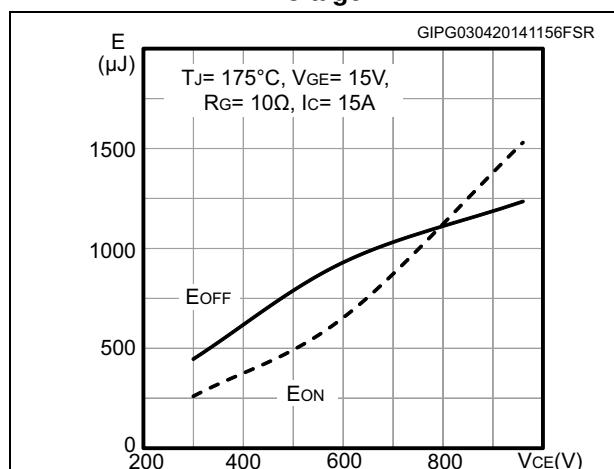
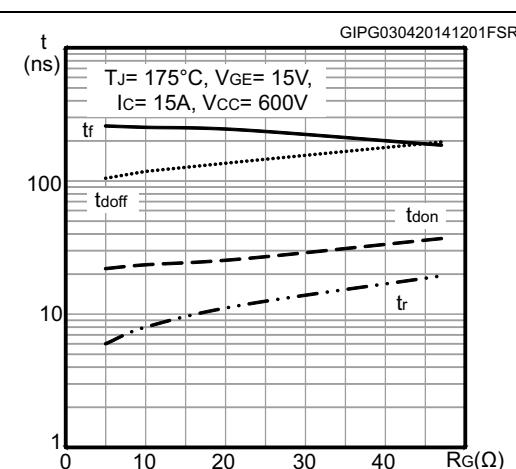
Figure 14. Gate charge vs. gate-emitter voltage**Figure 15. Switching loss vs collector current****Figure 16. Switching loss vs gate resistance****Figure 17. Switching loss vs temperature****Figure 18. Switching loss vs collector-emitter voltage****Figure 19. Switching times vs. gate resistance**

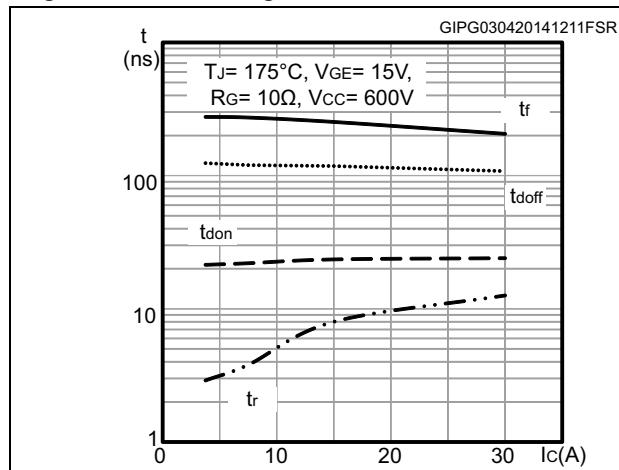
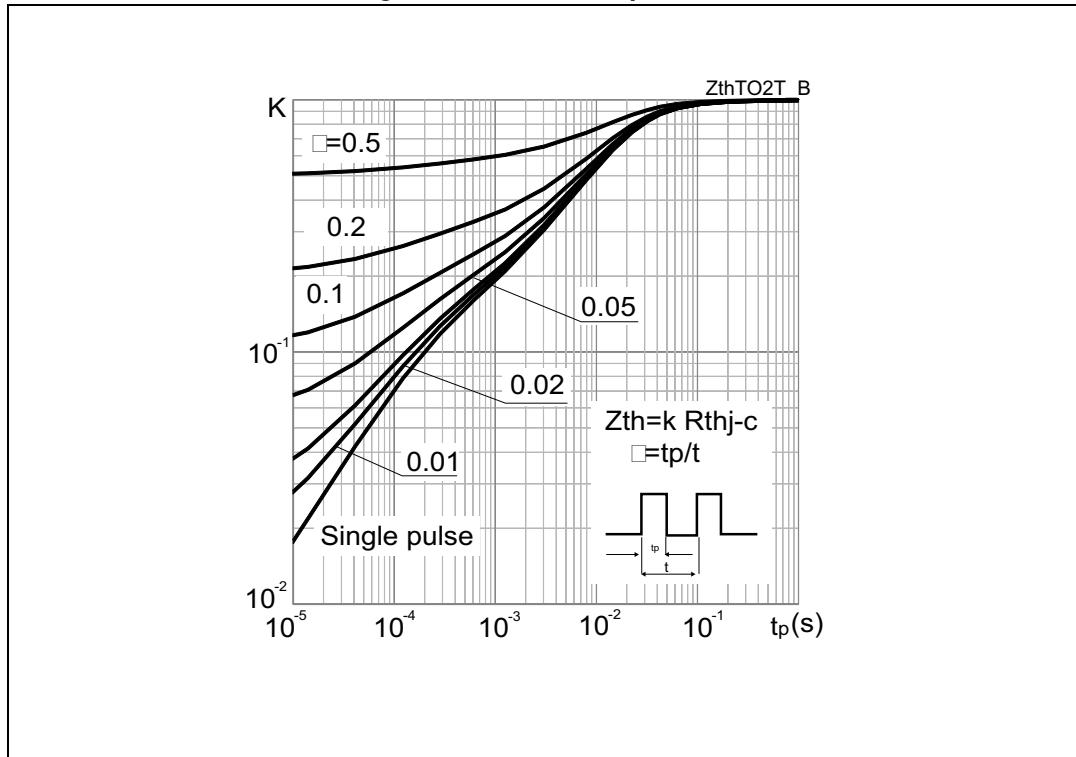
Figure 20. Switching times vs. collector current

Figure 21. Thermal impedance



3 Test circuits

Figure 22. Test circuit for inductive load switching

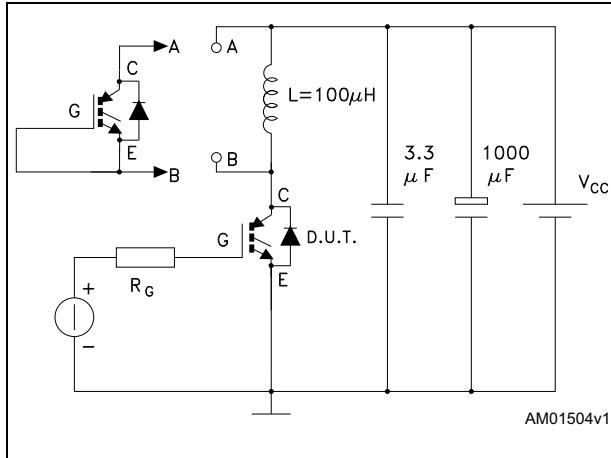


Figure 23. Gate charge test circuit

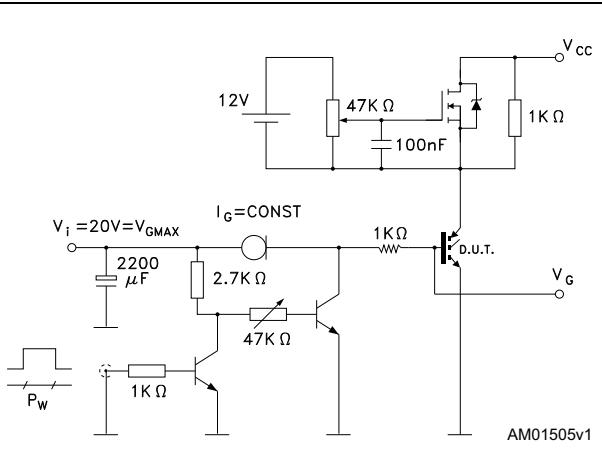
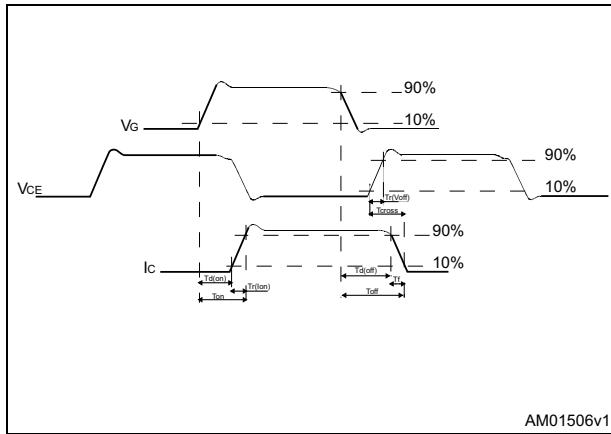


Figure 24. Switching waveform



4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com.
ECOPACK® is an ST trademark.

4.1 TO-247 package information

Figure 25. TO-247 package outline

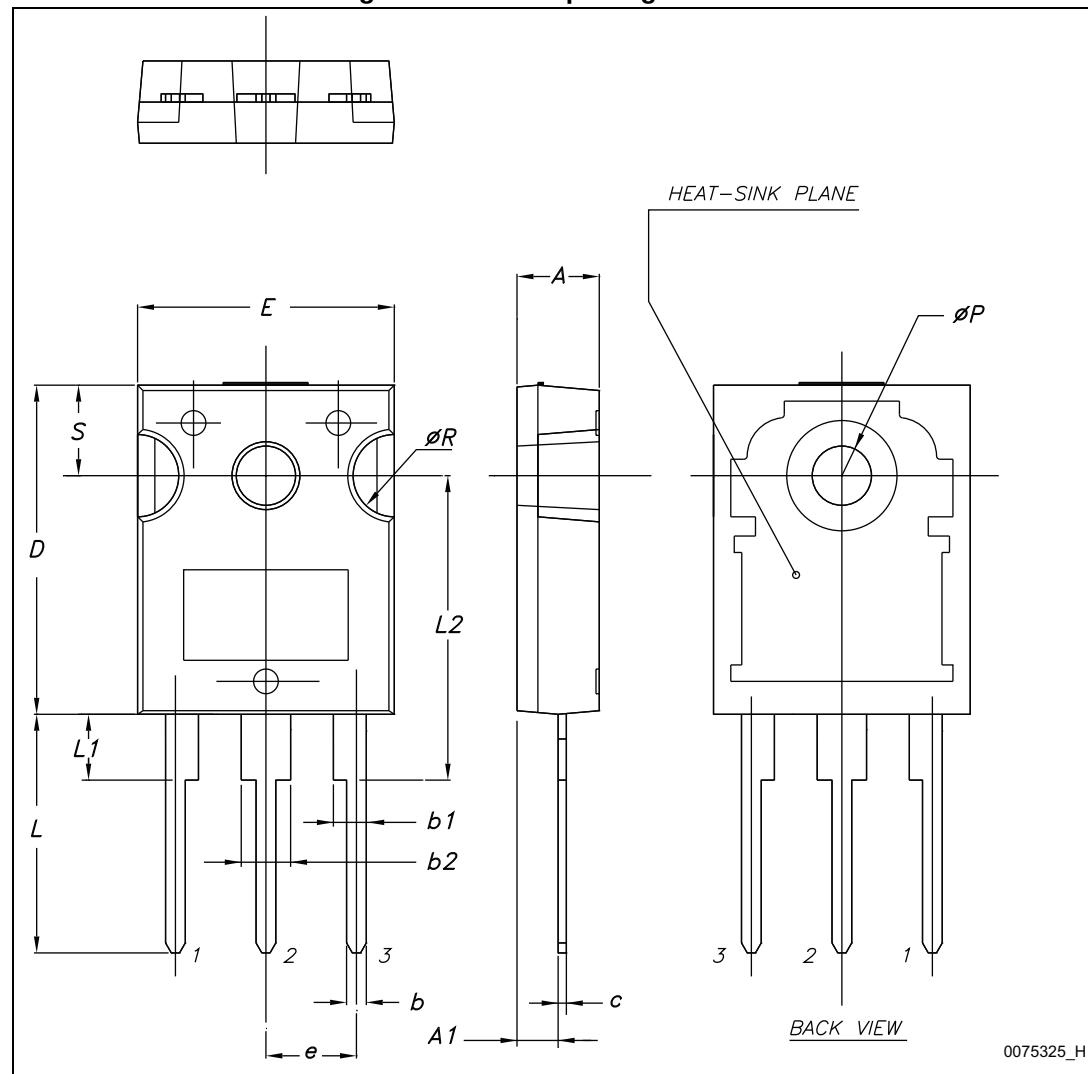


Table 7. TO-247 package mechanical data

Dim.	mm.		
	Min.	Typ.	Max.
A	4.85		5.15
A1	2.20		2.60
b	1.0		1.40
b1	2.0		2.40
b2	3.0		3.40
c	0.40		0.80
D	19.85		20.15
E	15.45		15.75
e	5.30	5.45	5.60
L	14.20		14.80
L1	3.70		4.30
L2		18.50	
ØP	3.55		3.65
ØR	4.50		5.50
S	5.30	5.50	5.70

4.2 TO-247 long leads package information

Figure 26. TO-247 long leads package outline

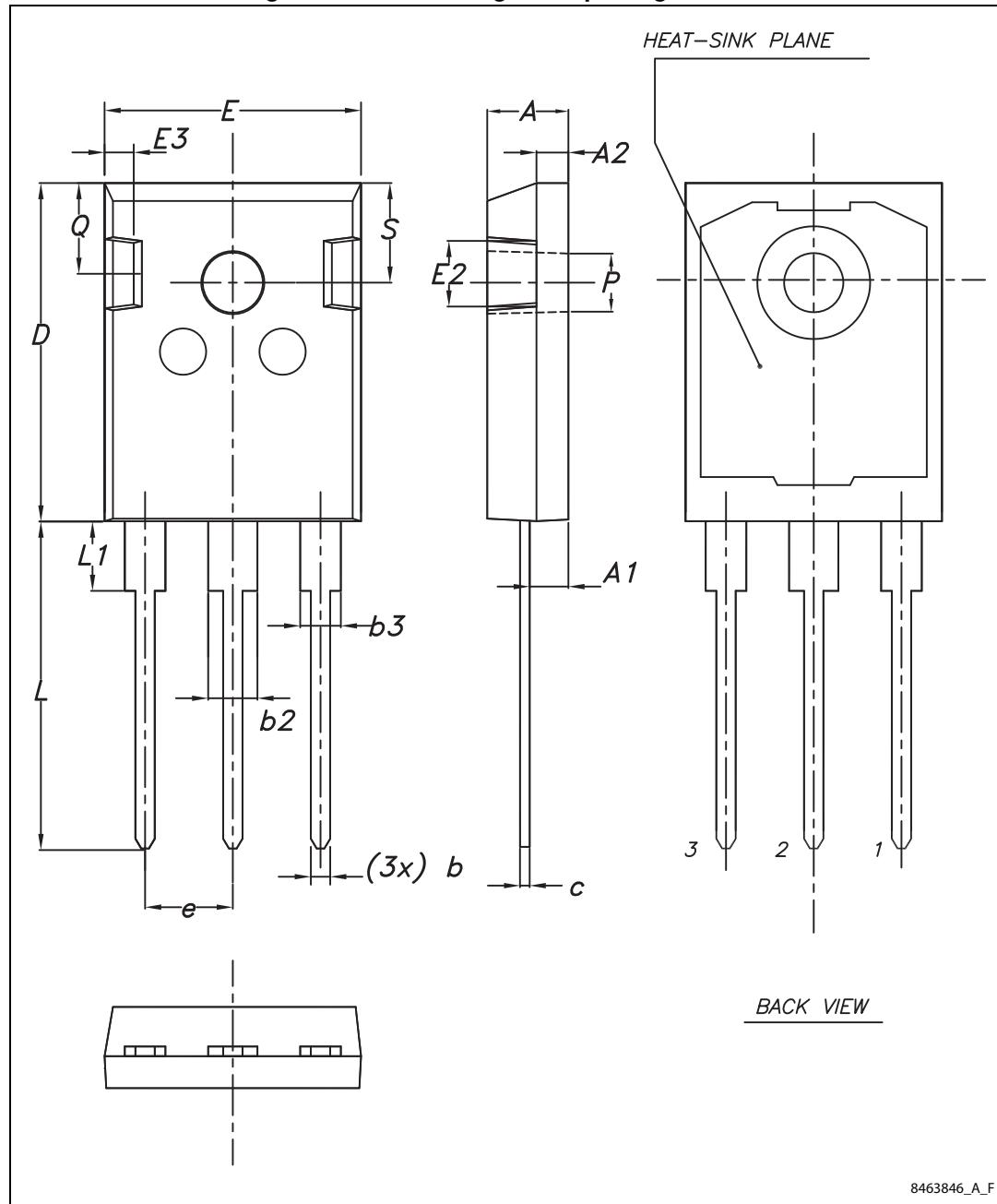


Table 8. TO-247 long leads package mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	4.90	5.00	5.10
A1	2.31	2.41	2.51
A2	1.90	2.00	2.10
b	1.16		1.26
b2			3.25
b3			2.25
c	0.59		0.66
D	20.90	21.00	21.10
E	15.70	15.80	15.90
E2	4.90	5.00	5.10
E3	2.40	2.50	2.60
e	5.34	5.44	5.54
L	19.80	19.92	20.10
L1			4.30
P	3.50	3.60	3.70
Q	5.60		6.00
S	6.05	6.15	6.25

5 Revision history

Table 9. Document revision history

Date	Revision	Changes
03-Mar-2014	1	Initial release.
08-Apr-2014	2	Document status promoted from preliminary to production data. Added Section 2.1: Electrical characteristics (curves) . Minor text changes.
28-Jan-2015	3	updated 4.1: TO-247 package information and 4.2: TO-247 long leads package information Minor text changes
04-Mar-2015	4	Updated Figure 4.: Output characteristics ($T_J = 25^\circ\text{C}$) Minor text changes.
01-Apr-2015	5	Removed figure of Diode reverse recovery waveform Minor text changes.

IMPORTANT NOTICE – PLEASE READ CAREFULLY

STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST's terms and conditions of sale in place at the time of order acknowledgement.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of Purchasers' products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2015 STMicroelectronics – All rights reserved